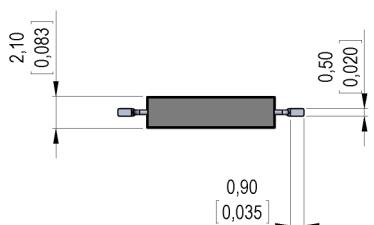


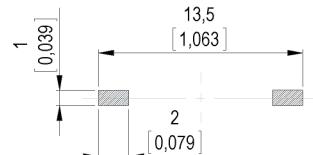
Isometric
 Scale 2:1
 Maßstab 2:1



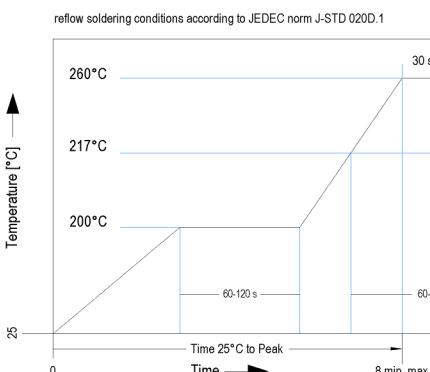
Marking
 according to EN60062/factory code
 gem. EN60062/Fertigungsstätte

B YW

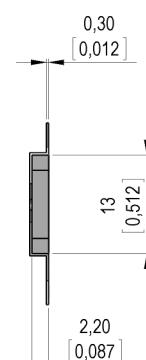
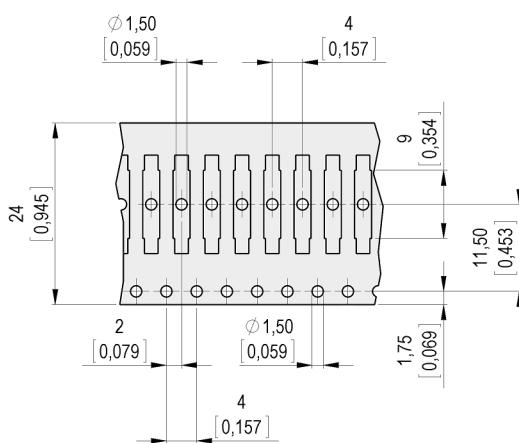
Recommended PCB Pad Layout



Solder Reflow Profile



Packaging



Modifications in the sense of technical progress are reserved

Designed at: 03.11.08 Designed by: THAUBE
 Last Change at: 13.12.13 Last Change by: THAUBE

Approval at: 05.11.08 Approval by: JHEYDER
 Approval at: 16.12.13 Approval by: AWEBER

Version: 16



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Item No.:
9171800022
Item:
MK17-B-2

Magnetic properties	Conditions	Min	Typ	Max	Unit
Pull-In	at 20°C	28		48	
Test equipment				KMS-11	
Pull-In in milliTesla (modified conta	MS150 - phys. caused tolerance +/- 0,1mT	1,63		2,4	mT
Test equipment				MS-150	

Contact data 80	Conditions	Min	Typ	Max	Unit
Contact-material				Rhodium	
Contact-rating	Any DC combination of V & A not to exceed their individual max.'s			10	W
Switching voltage	DC or Peak AC			100	V
Carry current	DC or Peak AC			0,5	A
Switching current	DC or Peak AC			0,5	A
Contact resistance static	Measured with 40% overdrive Start Value			250	mOhm
Breakdown voltage	according to IEC 255-5	150			VDC

Special Product Data	Conditions	Min	Typ	Max	Unit
Housing material				epoxy resin	
Material				EN 60335-1 conform	

Environmental data	Conditions	Min	Typ	Max	Unit
Shock	1/2 sine wave duration 11ms			30	g
Vibration	from 10 - 2000 Hz			20	g
Operating temperature		-40		130	°C
Storage temperature		-50		130	°C
Soldering Temperature Tsold	Reflow acc.IPC/JEDEC J-STD-020D.1			260	°C
Washability				fully sealed	

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Approval at: 05.11.08 Approval by: JHEYDER

Last Change at: 13.12.13 Last Change by: THAUKE

Approval at: 16.12.13 Approval by: AWEBER

Version: 16